

Title (en)  
Method of fitting floors

Title (de)  
Verfahren zum Verlegen von Böden

Title (fr)  
Procédé pour la pose de planchers

Publication  
**EP 1741852 A3 20081224 (EN)**

Application  
**EP 06386020 A 20060706**

Priority  
GR 20050100354 A 20050708

Abstract (en)  
[origin: EP1741852A2] New floor joining method of any material shape and size consists of: (a) circular ring made of any material, has one or more projecting points Drawing Fig.5 and Fig.6. (b) Slabs of any material, shape and size with one or more cavities corresponding the projecting points of the ring Drawing Fig.1. Application : The rings is placed on the ground and the slaps on it Drawing Fig 2, Fig3, Fig4, so the joining of the slabs on the ring takes occurs.

IPC 8 full level  
**E04F 15/02** (2006.01)

CPC (source: EP GR)  
**E04F 15/02** (2013.01 - EP GR); **E04F 15/02005** (2013.01 - GR); **E04F 15/04** (2013.01 - GR); **E04F 2201/05** (2013.01 - EP)

Citation (search report)  
• [X] DE 20201654 U1 20020425 - SIEMENS AG [DE]  
• [X] US 5479745 A 19960102 - KAWAI YOSHINARI [JP], et al

Cited by  
DE102008044803B4; US7958688B2; ES2325710A1; ES2325753A1; ES2326202A1; ES2326613A1

Designated contracting state (EPC)  
AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HU IE IS IT LI LT LU LV MC NL PL PT RO SE SI SK TR

Designated extension state (EPC)  
AL BA HR MK RS

DOCDB simple family (publication)  
**EP 1741852 A2 20070110; EP 1741852 A3 20081224; GR 1005297 B 20060922**

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